

Surface Mount  **RF Transformer**

50Ω 10 to 4000 MHz

TCM1-43X+



Generic photo used for illustration purposes only

CASE STYLE: DB1627

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Available Tape and Reel at no extra cost	
Reel Size	Devices/Reel
7"	20, 50, 100, 200, 500
13"	1000, 2000

Features

- wide bandwidth 10 to 4000 MHz
- balanced transmission line
- low insertion loss, 1.1 dB typ.
- excellent return loss
- aqueous washable

Applications

- PCS
- wideband push-pull amplifiers
- cellular

Electrical Specifications at 25°C

Parameter	Frequency (MHz)	Min.	Typ.	Max.	Unit
Impedance Ratio			1		
Frequency Range		10		4000	MHz
Insertion Loss	10-4000	—	1.1	3.0	dB
Amplitude Unbalance	10-4000	—	0.5	—	dB
Phase Unbalance	10-4000	—	7	—	Degree

Maximum Ratings

Parameter	Ratings
Operating Temperature	-40°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.4W
DC Current	30mA

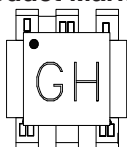
Permanent damage may occur if any of these limits are exceeded.

Pin Connections*

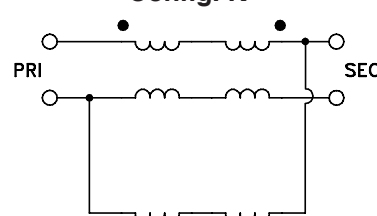
Function	Pin Number
PRIMARY DOT	3
PRIMARY	1, 2
SECONDARY DOT	6
SECONDARY	4
GND	1, 2
NOT USED	5

*Pin 1 and 2 must be connected together to form Config. K; We recommend grounding this side of the primary as shown in PL-364.

Product Marking

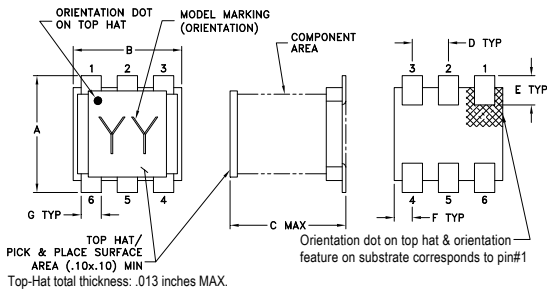


Config. K



TCM1-43X+

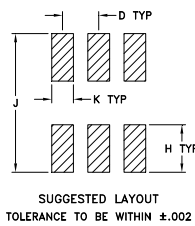
Outline Drawing



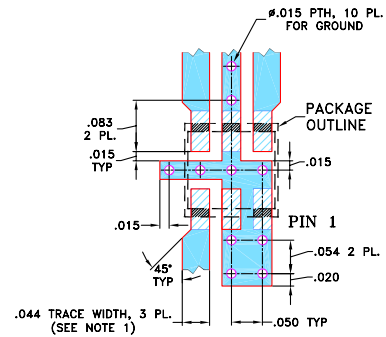
Outline Dimensions (inch/mm)

A	B	C	D	E	F
.160	.150	.160	.050	.040	.025
4.06	3.81	4.06	1.27	1.02	0.64
G	H	J	K	wt	
.028	.065	.190	.030	grams	
0.71	1.65	4.83	0.76	0.15	

PCB Land Pattern



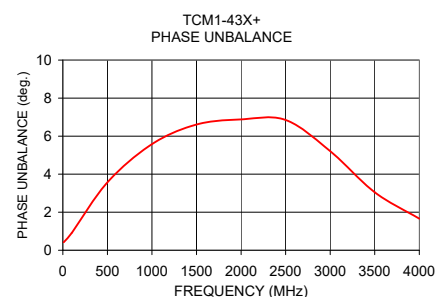
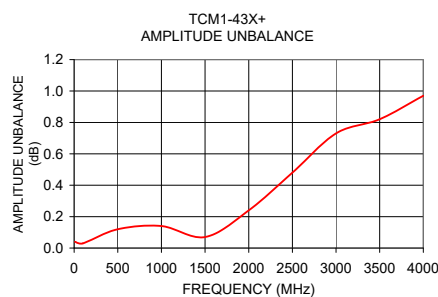
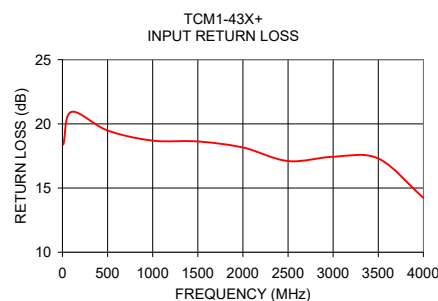
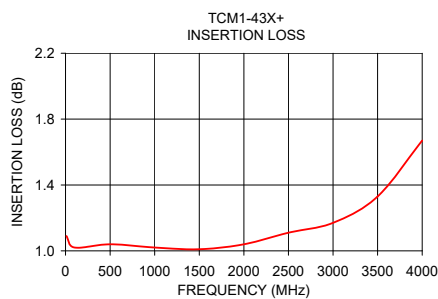
Demo Board MCL P/N: TB-654+ Suggested PCB Layout (PL-364)



- NOTES: 1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. ON EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.
- Denotes PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
 - Denotes COPPER LAND PATTERN FREE OF SOLDER MASK

Typical Performance Data

Frequency (MHz)	Insertion Loss (dB)	Input R. Loss (dB)	Amplitude Unbalance (dB)	Phase Unbalance (Deg.)
10	1.09	18.38	0.04	0.42
100	1.02	20.93	0.03	0.91
500	1.04	19.48	0.12	3.57
1000	1.02	18.69	0.14	5.58
1500	1.01	18.63	0.07	6.61
2000	1.04	18.16	0.24	6.88
2500	1.11	17.10	0.48	6.85
3000	1.17	17.44	0.73	5.21
3500	1.33	17.30	0.82	3.05
4000	1.67	14.24	0.97	1.66



Additional Notes

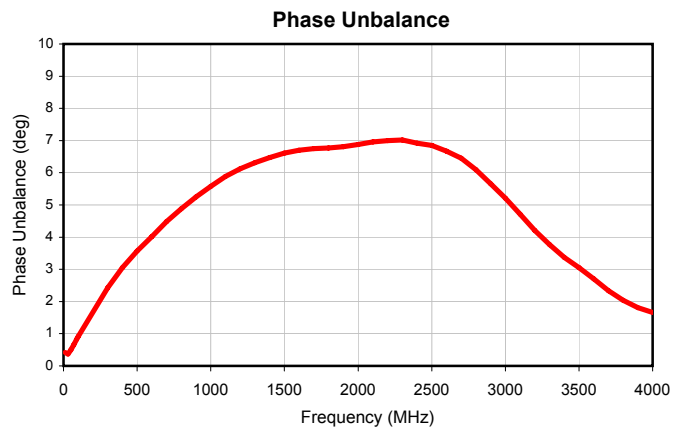
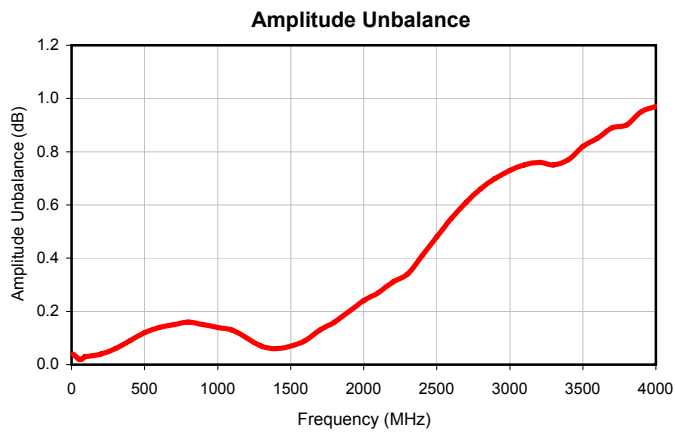
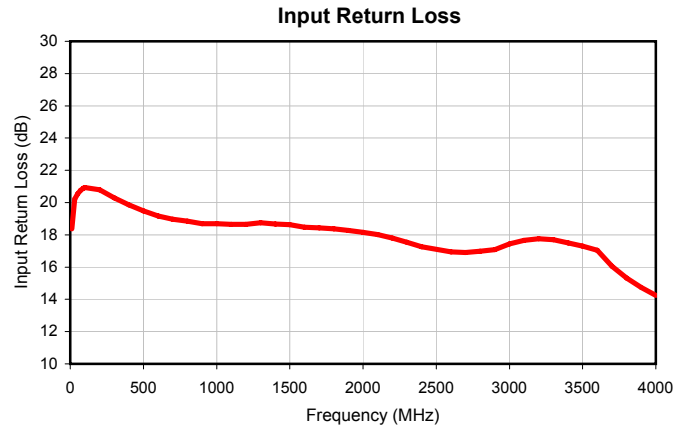
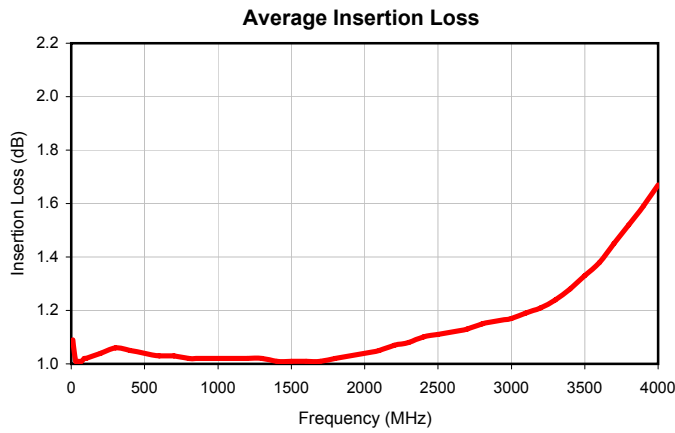
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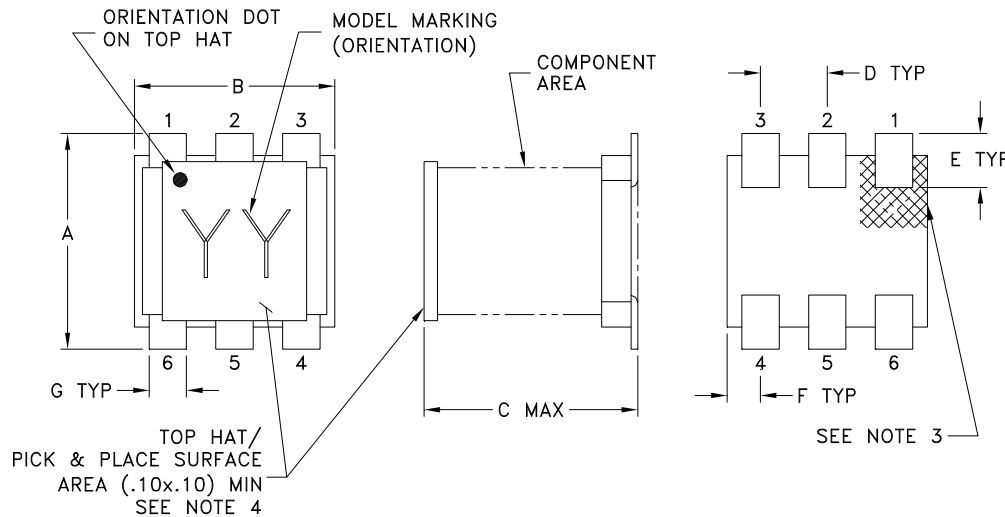
Typical Performance Data

FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg.)
10.0	1.09	18.38	0.04	0.42
30.0	1.01	20.22	0.03	0.37
50.0	1.01	20.54	0.02	0.50
70.0	1.01	20.76	0.02	0.66
90.0	1.02	20.90	0.03	0.83
100.0	1.02	20.93	0.03	0.91
200.0	1.04	20.79	0.04	1.67
300.0	1.06	20.30	0.06	2.43
400.0	1.05	19.86	0.09	3.05
500.0	1.04	19.48	0.12	3.57
600.0	1.03	19.16	0.14	4.02
700.0	1.03	18.97	0.15	4.48
800.0	1.02	18.85	0.16	4.88
900.0	1.02	18.69	0.15	5.25
1000.0	1.02	18.69	0.14	5.58
1100.0	1.02	18.66	0.13	5.88
1200.0	1.02	18.65	0.10	6.12
1300.0	1.02	18.75	0.07	6.31
1400.0	1.01	18.67	0.06	6.47
1500.0	1.01	18.63	0.07	6.61
1600.0	1.01	18.47	0.09	6.70
1700.0	1.01	18.44	0.13	6.75
1800.0	1.02	18.38	0.16	6.77
1900.0	1.03	18.27	0.20	6.81
2000.0	1.04	18.16	0.24	6.88
2100.0	1.05	18.01	0.27	6.96
2200.0	1.07	17.80	0.31	7.00
2300.0	1.08	17.54	0.34	7.02
2400.0	1.10	17.26	0.41	6.92
2500.0	1.11	17.10	0.48	6.85
2600.0	1.12	16.95	0.55	6.67
2700.0	1.13	16.90	0.61	6.45
2800.0	1.15	16.98	0.66	6.09
2900.0	1.16	17.08	0.70	5.66
3000.0	1.17	17.44	0.73	5.21
3100.0	1.19	17.65	0.75	4.71
3200.0	1.21	17.76	0.76	4.20
3300.0	1.24	17.70	0.75	3.77
3400.0	1.28	17.50	0.77	3.37
3500.0	1.33	17.30	0.82	3.05
3600.0	1.38	17.05	0.85	2.70
3700.0	1.45	16.05	0.89	2.34
3800.0	1.52	15.31	0.90	2.04
3900.0	1.59	14.74	0.95	1.81
4000.0	1.67	14.24	0.97	1.66

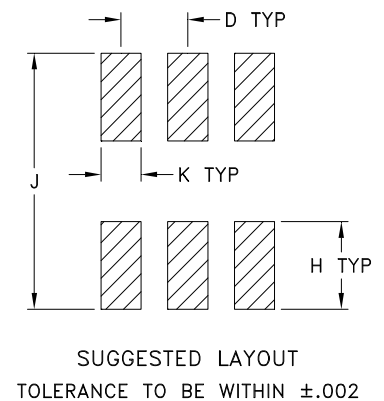
Typical Performance Data



Outline Dimensions



PCB Land Pattern



CASE #	A	B	C	D	E	F	G	H	J	K	WT. GRAM
DB1627	.160 (4.06)	.150 (3.81)	.160 (4.06)	.050 (1.27)	.040 (1.02)	.025 (0.64)	.028 (0.71)	.065 (1.65)	.190 (4.83)	.030 (0.76)	.15

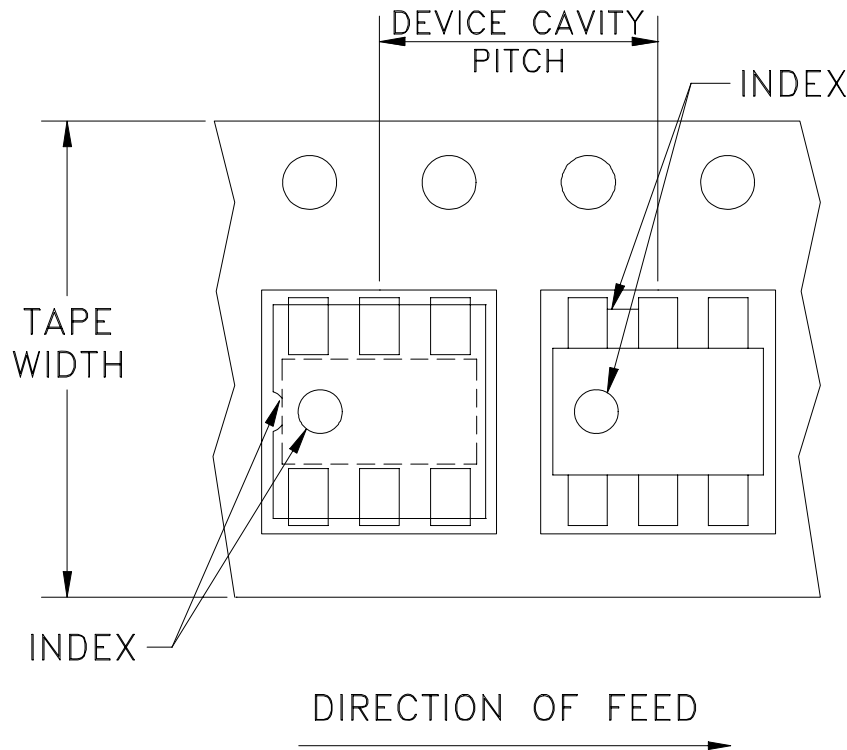
Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.
- Orientation dot on top hat & orientation feature on substrate correspondence to pin #1.
- Top-Hat total thickness: .013 inches MAX.

Tape & Reel Packaging TR-F47

DEVICE ORIENTATION IN T&R



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note
12	8	13	1000, 2000
		7	20, 50, 100, 200, 500

Note: Please consult individual model data sheet to determine device per reel availability.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

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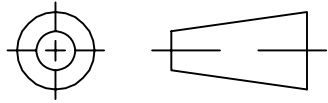
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THIRD ANGLE PROJECTION

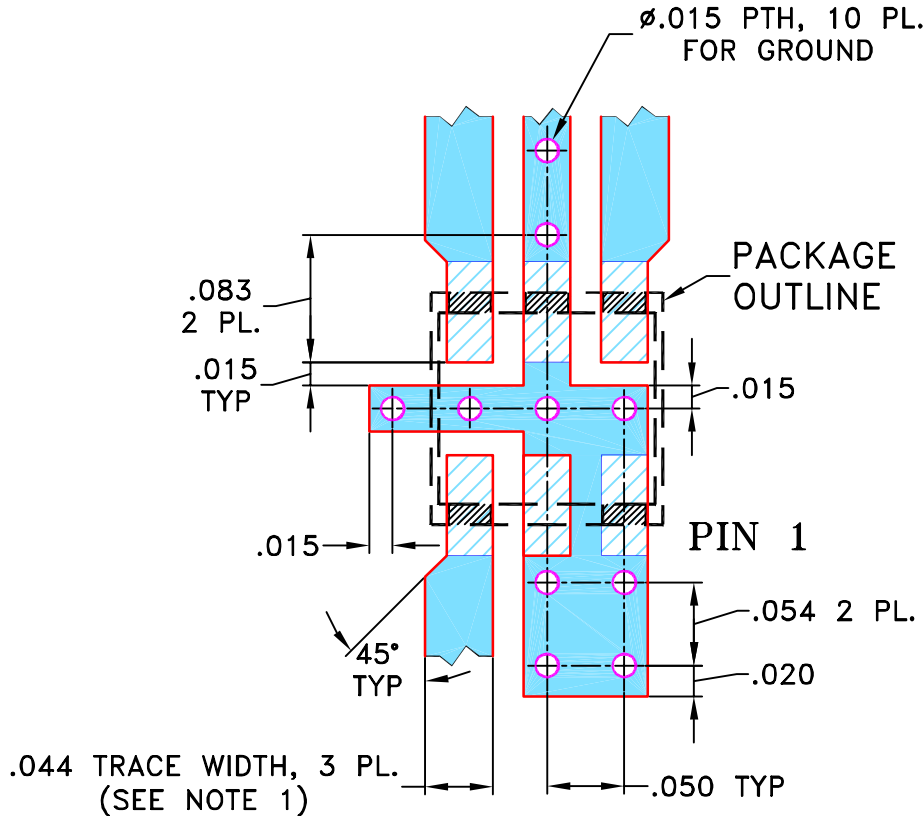


REVISIONS

REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M136032	NEW RELEASE	03/07/12	GF	DJ
A	M141464	ADDED PIN CODE "06TK04"	05/06/13	IL	DJ

SUGGESTED MOUNTING CONFIGURATION

FOR DB1627 CASE STYLE, "06TN01" & "06TK04" PIN CODES



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2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED

INITIALS DATE

DIMENSIONS ARE IN INCHES
 TOLERANCES ON:
 2 PL DECIMALS ±
 3 PL DECIMALS ± .005
 ANGLES ±
 FRACTIONS ±

DRAWN	GF	02/17/12
CHECKED	IL	03/07/12
APPROVED	DJ	03/07/12



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 Brooklyn NY 11235

PL, 06TN01/06TK04, DB1627, TB-654+

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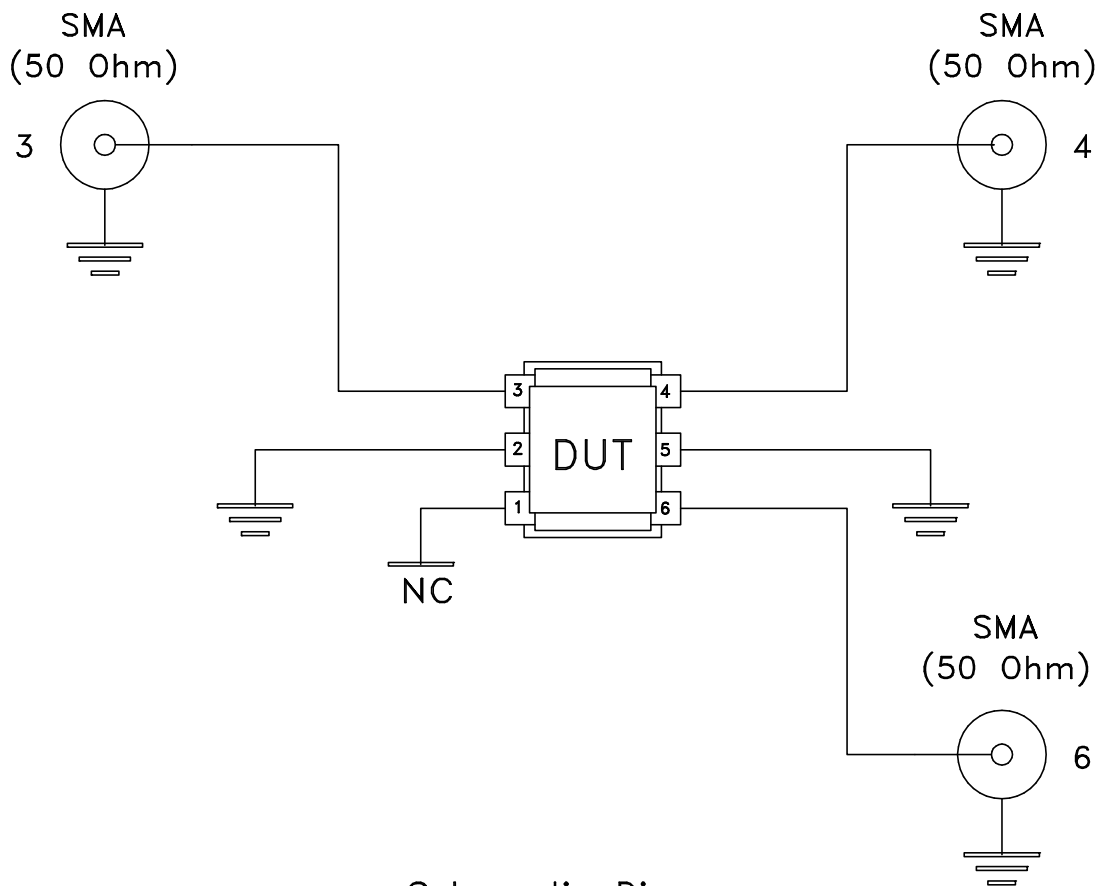
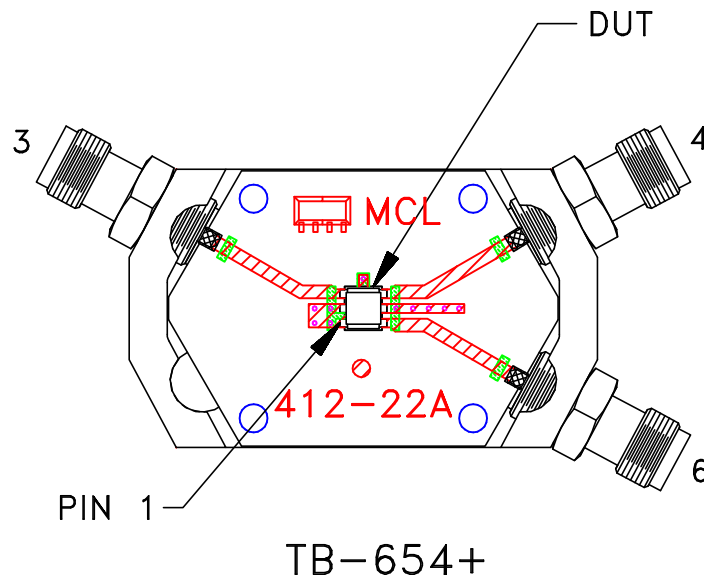
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SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-364	REV: A
FILE: 98PL364	SCALE: 8:1	SHEET: 1 OF 1	

ASHEETA1.DWG REV:A DATE:01/12/95

Evaluation Board and Circuit


For Pin Connections refer to Data Sheet of the DUT



Schematic Diagram

Notes:

1. 50 Ohm SMA Female connectors.
2. PCB Material: R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**

All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215